### **BAT54-Y**

### Automotive small signal Schottky diodes

#### **Features**

- Low conduction and reverse losses
- Negligible switching losses
- Low forward and reverse recovery times
- Extremely fast switching
- Surface mount device
- Low capacitance diode
- ECOPACK®2 compliant component
- AEC-Q101 qualified

### **Description**

The BAT54 series uses 40 V Schottky barrier diodes packaged in SOT-23, SOT-323. These devices are suitable for automotive application.

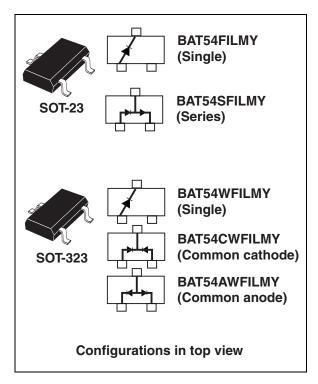


Table 1. Device summary

Symbol	Value
I <sub>F</sub>	300 mA
V <sub>RRM</sub>	40 V
C (typ)	7 pF
T <sub>j</sub> (max)	150 °C

Characteristics BAT54-Y

#### 1 Characteristics

Table 2. Absolute ratings (limiting values at  $T_i = 25$  °C, unless otherwise specified)

Symbol	Parameter	Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage	40	V
I <sub>F</sub>	Continuous forward current	300	mA
I <sub>FSM</sub>	Surge non repetitive forward current	1	Α
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C
T <sub>j</sub>	Operating junction temperature range	-40 to +150	°C
TL	Maximum soldering temperature	260	°C

Table 3. Thermal parameters

Symbol	Parameter	Value	Unit
D	Junction to ambient <sup>(1)</sup>	500	°C/W
R <sub>th(j-a)</sub>	SOT-323	550	°C/W

<sup>1.</sup> Epoxy printed circuit board with recommended pad layout

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit	
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage	T <sub>j</sub> = 25 °C	$T_j = 25  ^{\circ}\text{C}$ $V_B = 30  \text{V}$			1	μΑ	
'R'	current $T_j = 100  ^{\circ}\text{C}$	T <sub>j</sub> = 100 °C V <sub>R</sub> = 30 V	VR - 50 V			100	μΛ	
	V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	ward voltage drop $T_j = 25 ^{\circ}\text{C}$	I <sub>F</sub> = 0.1 mA	$I_F = 0.1 \text{ mA}$			240	
			I <sub>F</sub> = 1 mA			320		
V <sub>F</sub> <sup>(2)</sup>			I <sub>F</sub> = 10 mA			400	mV	
			I <sub>F</sub> = 30 mA			500		
			I <sub>F</sub> = 100 mA			900		

<sup>1.</sup> Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2 %

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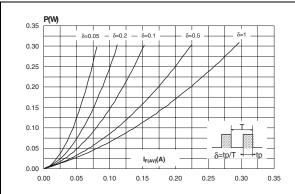
Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
С	Diode capacitance	V <sub>R</sub> = 1 V, F = 1 MHz		7	10	pF
t <sub>rr</sub>	Reverse recovery time	$\begin{aligned} I_F &= 10 \text{ mA}, \ I_R = 10 \text{ mA}, \ T_j = 25 \text{ °C} \\ I_{rr} &= 1 \text{ mA}, \ R_L = 100 \ \Omega \end{aligned}$			5	ns

<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2 %

BAT54-Y Characteristics

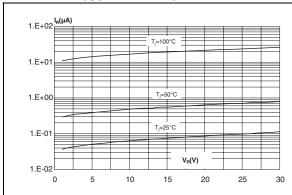
Figure 1. Average forward power dissipation Figure 2. Average forward current versus awbient temperature ( $\delta$  = 1)



0.35 | I<sub>F(AV)</sub>(A) 0.30 0.25 0.20 0.15 0.10 0.05  $\delta = tp/T$ T<sub>amb</sub>(°C) 0.00 0 50 75 100 125 150

Figure 3. Reverse leakage current versus reverse applied voltage (typical values)

Figure 4. Reverse leakage current versus junction temperature



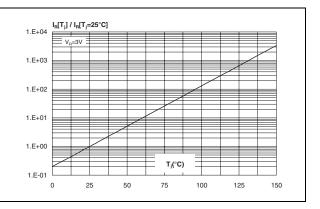
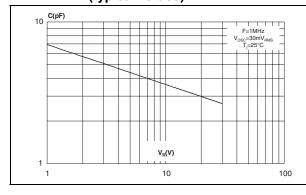
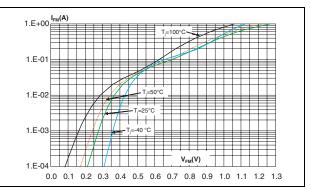


Figure 5. Junction capacitance versus reverse applied voltage (typical values)

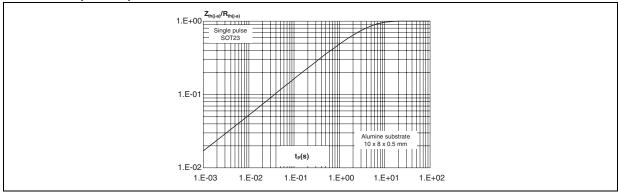
Figure 6. Forward voltage drop versus forward current (typical values)





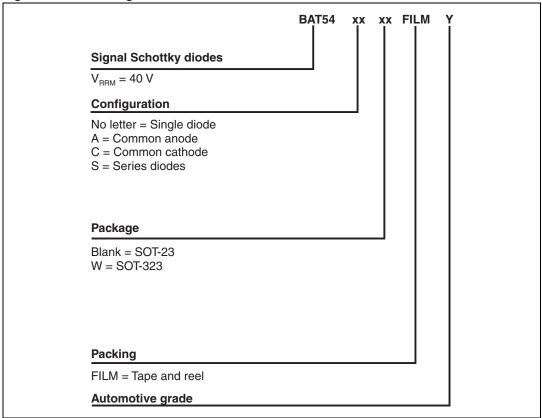
Characteristics BAT54-Y

Figure 7. Relative variation of thermal impedance junction to ambient versus pulse duration (SOT-23)



# 2 Ordering information scheme

Figure 8. Ordering information scheme



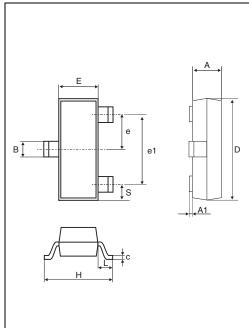


## 3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: <a href="www.st.com">www.st.com</a>. ECOPACK® is an ST trademark.

Table 6. SOT-23 dimensions



	Dimensions				
Ref.	Millimeters		Inc	nes	
	Min.	Max.	Min.	Max.	
Α	0.89	1.4	0.035	0.055	
A1	0	0.1	0	0.004	
В	0.3	0.51	0.012	0.02	
С	0.085	0.18	0.003	0.007	
D	2.75	3.04	0.108	0.12	
е	0.85	1.05	0.033	0.041	
e1	1.7	2.1	0.067	0.083	
Е	1.2	1.6	0.047	0.063	
Н	2.1	2.75	0.083	0.108	
L	0.6 typ.		0.02	4 typ.	
S	0.35	0.65	0.014	0.026	

Figure 9. SOT-23 footprint (dimensions in mm)

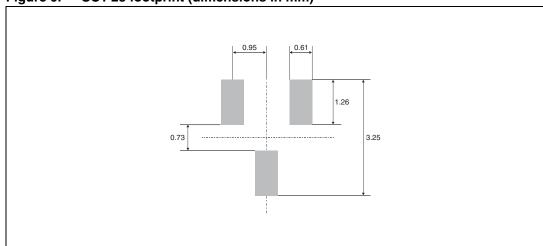


Table 7. SOT-323 dimensions

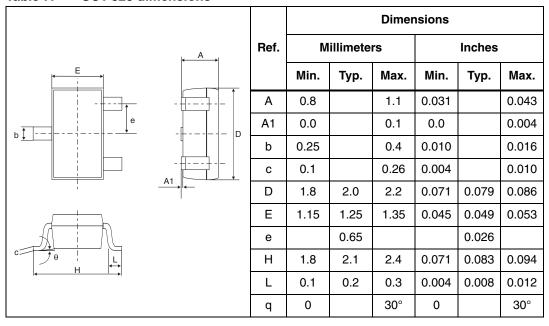
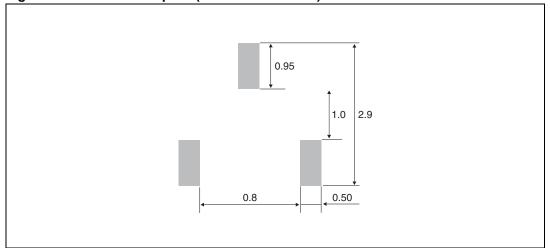


Figure 10. SOT-323 footprint (dimensions in mm)



Ordering information BAT54-Y

# 4 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode	
BAT54FILMY	86Y	SOT-23 Single	10 mg			
BAT54SFILMY	88Y	SOT-23 Serial	10 mg			
BAT54WFILMY	73Y	SOT-323 Single	6 mg			
BAT54CWFILMY	77Y	SOT-323 Common cathode	6 mg	3000	Tape and reel	
BAT54AWFILMY	74Y	SOT-323 Common anode	6 mg			

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
04-Nov-2011	1	Initial release.

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